

SANYO Semiconductors DATA SHEET

2SK2632LS-

N-Channel Silicon MOSFET

General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · Low Qg.
- · Ultrahigh-speed switching.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		800	V
Gate-to-Source Voltage	VGSS		±30	V
Drain Current (DC)	ID		2.5	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	7.5	Α
Allowable Power Dissipation	Do.		2.0	W
	PD	Tc=25°C	25	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Drain-to-Source Breakdown Voltage	V(BR)DSS	I _D =1mA, V _{GS} =0V	800			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =800V, V _{GS} =0V			1.0	mA
Gate-to-Source Leakage Current	IGSS	VGS=±30V, VDS=0V			±100	nA
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	3.5		5.5	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =1.3A	0.7	1.4		S
Static Drain-to-Source On-State Resistance	RDS(on)	ID=1.3A, VGS=15V		3.6	4.8	Ω

Marking: K2632 Continued on next page.

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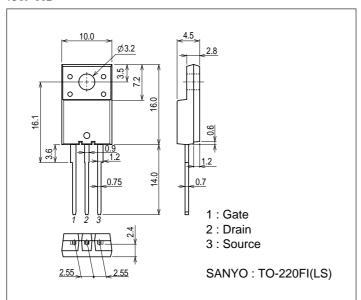
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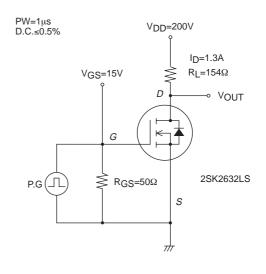
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Utill
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		550		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		150		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		70		pF
Total Gate Charge	Qg	V _{DS} =200V, I _D =2.5A, V _{GS} =10V		15		nC
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		15		ns
Rise Time	t _r	See specified Test Circuit.		15		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		45		ns
Fall Time	tf	See specified Test Circuit.		23		ns
Diode Forward Voltage	V _{SD}	I _S =2.5A, V _{GS} =0V		0.84	1.2	V

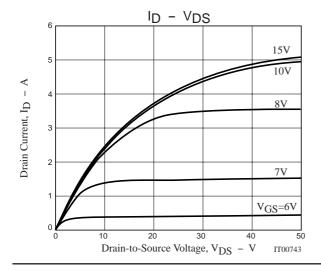
Package Dimensions

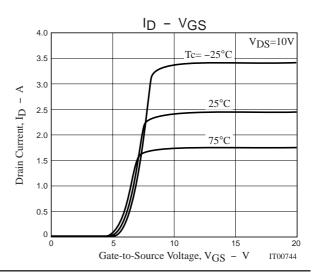
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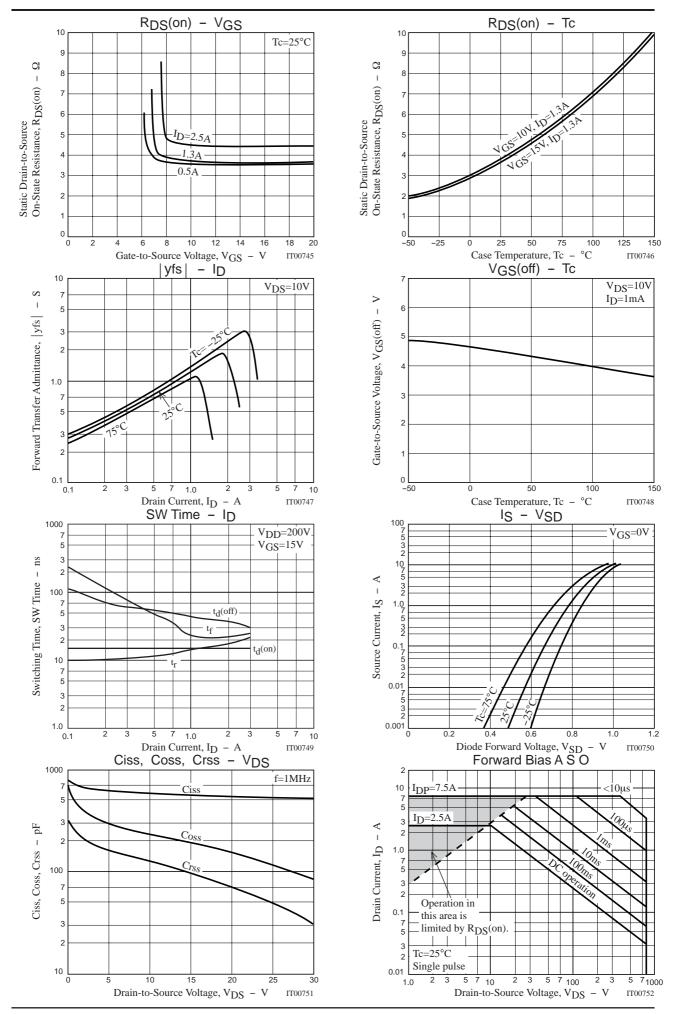


Switching Time Test Circuit

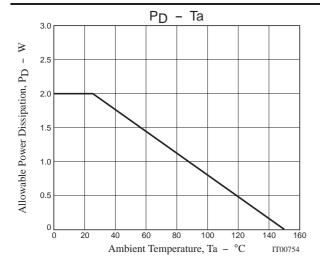


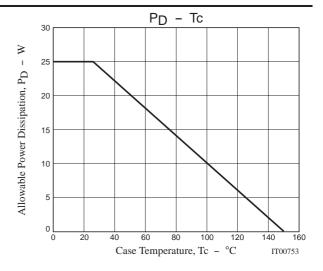






2SK2632LS





Note on usage : Since the 2SK2632LS is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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